

***EV-SOMCRR2-EZKIT*® Manual**

Revision 1.0, June 2026

Part Number
82-EV-SOMCRR-EZKIT-01

Copyright Information

© 2026 Analog Devices, Inc., ALL RIGHTS RESERVED. This document may not be reproduced in any form without prior, express written consent from Analog Devices, Inc.

Disclaimer

Analog Devices, Inc. reserves the right to change this product without prior notice. Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use; nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under the patent rights of Analog Devices, Inc.

Trademark and Service Mark Notice

The Analog Devices logo, Blackfin, Blackfin+, SHARC, SHARC+, CrossCore, VisualDSP++, EZ-KIT, EZ-Extender, and EngineerZone are registered trademarks of Analog Devices, Inc.

All other brand and product names are trademarks or service marks of their respective owners.

Regulatory Compliance

The *EV-SOMCRR2-EZKIT* evaluation board is designed to be used solely in a laboratory environment. The board is not intended for use as a consumer-end product or as a portion of a consumer-end product. The board is an open system design, which does not include a shielded enclosure and, therefore, may cause interference to other electrical devices in close proximity. This board should not be used in or near any medical equipment or RF devices.

The *EV-SOMCRR2-EZKIT* evaluation board contains ESD (electrostatic discharge) sensitive devices. Electrostatic charges readily accumulate on the human body and equipment and can discharge without detection. Permanent damage may occur on devices subjected to high-energy discharges. Proper ESD precautions are recommended to avoid performance degradation or loss of functionality. Store unused boards in the protective shipping package.



Contents

Preface

Purpose of This Manual.....	1-1
Manual Contents.....	1-1
Technical Support.....	1-2
Supported Tools.....	1-2
Product Information.....	1-3
Analog Devices Website.....	1-3
EngineerZone.....	1-3

Using the Board

Product Overview.....	2-1
Package Contents.....	2-2
Default Configuration.....	2-3
CrossCore Embedded Studio (CCES) Setup.....	2-3
Debug Agent.....	2-3
Power-On-Self Test.....	2-4
Reference Design Information.....	2-4
Automotive Audio Bus A ² B Interface.....	2-4
25LC010AT - 1K SPI Serial EEPROM.....	2-4
ADAU1966A - 16 Channel, High Performance, 192kHz, 24-Bit DAC.....	2-5
ADAU1979 - Quad Analog-to-Digital Converter.....	2-5
ADM3056E - Signal and Power Isolated CAN Transceiver.....	2-5
ADIN1300CCPZ- 10/100/1000 Ethernet Physical Layer.....	2-6
IS25LX256 - 256M-bit Serial Octal Flash Memory.....	2-6

Hardware Reference

System Architecture.....	3-1
Software-Controlled Switches (SoftConfig).....	3-3

Overview of SoftConfig.....	3-3
SoftConfig on the Board.....	3-6
Programming SoftConfig Switches	3-6
Switches.....	3-9
Reset Pushbutton (RESET)	3-10
GPIO Pushbuttons (PB1, PB2, PB3, PB4).....	3-10
JTAG Interface (S11).....	3-10
Jumpers	3-11
DAC Clock(P36)	3-11
HADC (P4 and P5).....	3-11
LEDs	3-12
A ² B Interface LEDs (DS7, DS8, DS9, DS10, DS11, DS12)	3-12
GPIO (DS1, DS2, DS3, DS4, DS5, DS6, PB1_LED, PB2_LED, PB3_LED, PB4_LED)..	
.....	3-12
Reset (DS23)	3-13
Connectors	3-13
SoM 2.0 Interface Connection (SOMA, SOMB)	3-14
Audio Input/Output (P13, P15, P16).....	3-16
Audio Output (P11, P12, P13, P14).....	3-17
S/PDIF Digital (J1, J2)	3-17
S/PDIF Optical Tx/RX (M1, M2).....	3-17
MLB (P38, P42)	3-17
Sigma Studio (P30, P31).....	3-17
A ² B (J4, J5, P3, P4).....	3-17
Ethernet 10/100/1000 (P1, P2)	3-18
Power Plug (P7)	3-18

1 Preface

Thank you for purchasing the Analog Devices, Inc. *EV-SOMCRR2-EZKIT* carrier evaluation board.

The *EV-SOMCRR2-EZKIT* carrier board is a backplane plug-in card designed for use with System on Module (SoM) evaluation boards. Together, these boards create a full evaluation system to demonstrate Analog Devices embedded processor feature sets. The SoM module features the processor, required power, and external memory circuitry; and the carrier board provides all the peripheral functionality necessary to evaluate an embedded application.

The *EV-SOMCRR2-EZKIT* carrier board is compatible with numerous SoM boards and works with the Analog Devices development tools to test the capabilities of Analog Devices processors.

The evaluation board is designed to be used in conjunction with the CrossCore Embedded Studio® development environment for advanced application code development and debug, with features that enable the ability to:

- Create, compile, assemble, and link application programs written in C++, C, and assembly
- Load, run, step, halt, and set breakpoints in application programs
- Read and write data and program memory
- Read and write core and peripheral registers

In addition to the system peripherals, there is an on-board debugger on the *EV-SOMCRR2-EZKIT* carrier board. The on-board debugger eliminates the need to purchase the In-Circuit Emulator (ICE) that is necessary when using a SoM module in standalone mode.

Purpose of This Manual

This manual provides instructions for installing the product hardware (board). This manual describes the operation and configuration of board components and provides guidelines for running code on the board.

Manual Contents

The manual consists of:

- *Using the board*

Provides basic board information.

- *Hardware Reference*

Provides information about the hardware aspects of the board.

- *Bill of Materials*

A companion file in PDF format that lists all of the components used on the board is available on the website at <http://www.analog.com/EV-SOMCRR2-EZKIT>.

- *Schematic*

A companion file in PDF format documenting all of the circuits used on the board is available on the website at <http://www.analog.com/EV-SOMCRR2-EZKIT>.

Technical Support

You can reach Analog Devices technical support in one of the following ways:

- Post your questions in the processors and DSP support community at EngineerZone®:

<http://ez.analog.com/community/dsp>

- Submit your questions to technical support directly at:

<http://www.analog.com/support>

- E-mail your questions about processors, DSPs, and tools development software from *CrossCore Embedded Studio* or *VisualDSP++*®:

If using CrossCore Embedded Studio or VisualDSP++ choose *Help > Email Support*. This creates an e-mail to processor.tools.support@analog.com and automatically attaches your CrossCore Embedded Studio or VisualDSP++ version information and `license.dat` file.

- E-mail your questions about processors and processor applications to:

processor.support@analog.com

- Contact your Analog Devices sales office or authorized distributor. Locate one at:

<http://www.analog.com/adi-sales>

Supported Tools

Information about code development tools for the *EV-SOMCRR2-EZKIT* evaluation board and SHARC-FX product family is available at:

<http://www.analog.com/EV-SOMCRR2-EZKIT>

Product Information

Product information can be obtained from the Analog Devices website and the online help system.

Information about the ADI product family is available at:

Analog Devices Website

The Analog Devices website, <http://www.analog.com>, provides information about a broad range of products - analog integrated circuits, amplifiers, converters, transceivers, and digital signal processors.

To access a complete technical library for each processor family, go to http://www.analog.com/processors/technical_library. The manuals selection opens a list of current manuals related to the product as well as a link to the previous revisions of the manuals. When locating your manual title, note a possible errata check mark next to the title that leads to the current correction report against the manual.

Also note, MyAnalog.com is a free feature of the Analog Devices website that allows customization of a web page to display only the latest information about products you are interested in. You can choose to receive weekly e-mail notifications containing updates to the web pages that meet your interests, including documentation errata against all manuals. MyAnalog.com provides access to books, application notes, data sheets, code examples, and more.

Visit MyAnalog.com to sign up. If you are a registered user, just log on. Your user name is your e-mail address.

EngineerZone

EngineerZone is a technical support forum from Analog Devices, Inc. It allows you direct access to ADI technical support engineers. You can search FAQs and technical information to get quick answers to your embedded processing and DSP design questions.

Use EngineerZone to connect with other DSP developers who face similar design challenges. You can also use this open forum to share knowledge and collaborate with the ADI support team and your peers. Visit <http://ez.analog.com> to sign up.

2 Using the Board

This chapter provides information on the major components and peripherals on the board, along with instructions for installing and setting up the emulation software.

Product Overview

Below is an image of the *EV-SOMCRR2-EZKIT* carrier board.

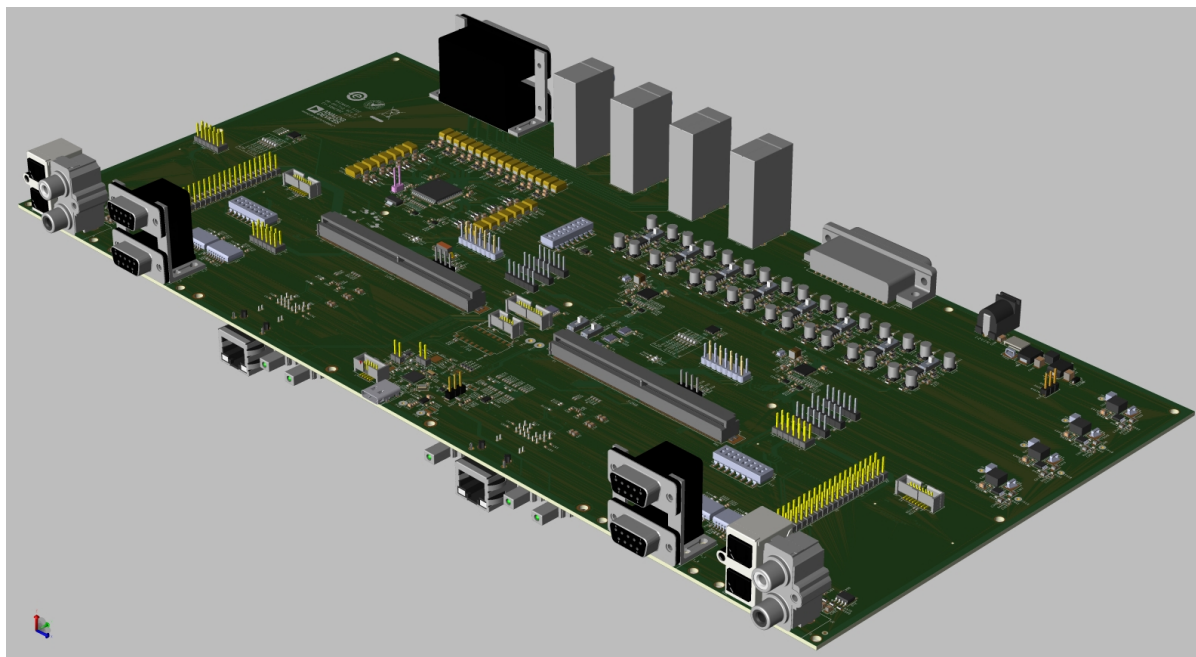


Figure 2-1: Board View

The board features:

- System-on-Module 2.0 (SoM 2.0) connector
 - Compatible with Analog Devices DSP SoMs
- xSPI flash (xSPI1) memory

- ISSI IS72WVO32M8AWO256-200HLA2
- 256Mbit MCP
- xSPI Flash and RAM combo
- SPI EEPROM
 - Microchip
- Audio
 - Analog Devices ADAU1966A
 - Analog Devices [ADAU1979 - Quad Analog-to-Digital Converter](#)
 - 9 3.5mm Stereo connectors: 16 outputs, 8 inputs
 - DB25 for TASCAM25 interface
- A²B
 - Two A²B interface connectors for the A²B mini modules per SOM location
- Ethernet
 - ADIN1300 10/100/1000 Gigabit Ethernet
- Debug Interface (JTAG)
 - On-Board debug agent
- LEDs
 - 24 LEDs: one board reset (red), 10 general-purpose (amber), 12 A²B LEDs, and one RGB LED for on-board debug agent
- Pushbuttons
 - Three pushbuttons: one reset and two IRQ/Flag
- External power supply
 - CE compliant
 - 12V @1.6 Amps

Package Contents

Your *EV-SOMCRR2-EZKIT* package contains the following items.

- *EV-SOMCRR2-EZKIT* board
- Universal 12V DC power supply

- Three USB 2.0 type A to C cable

Contact the vendor where you purchased your *EV-SOMCRR2-EZKIT* evaluation board or contact Analog Devices, Inc. if any item is missing.

Default Configuration

The *Default Hardware Setup* figure shows the default settings for jumpers and switches and the location of the jumpers, switches, connectors, and LEDs. Confirm that your board is in the default configuration before using the board.

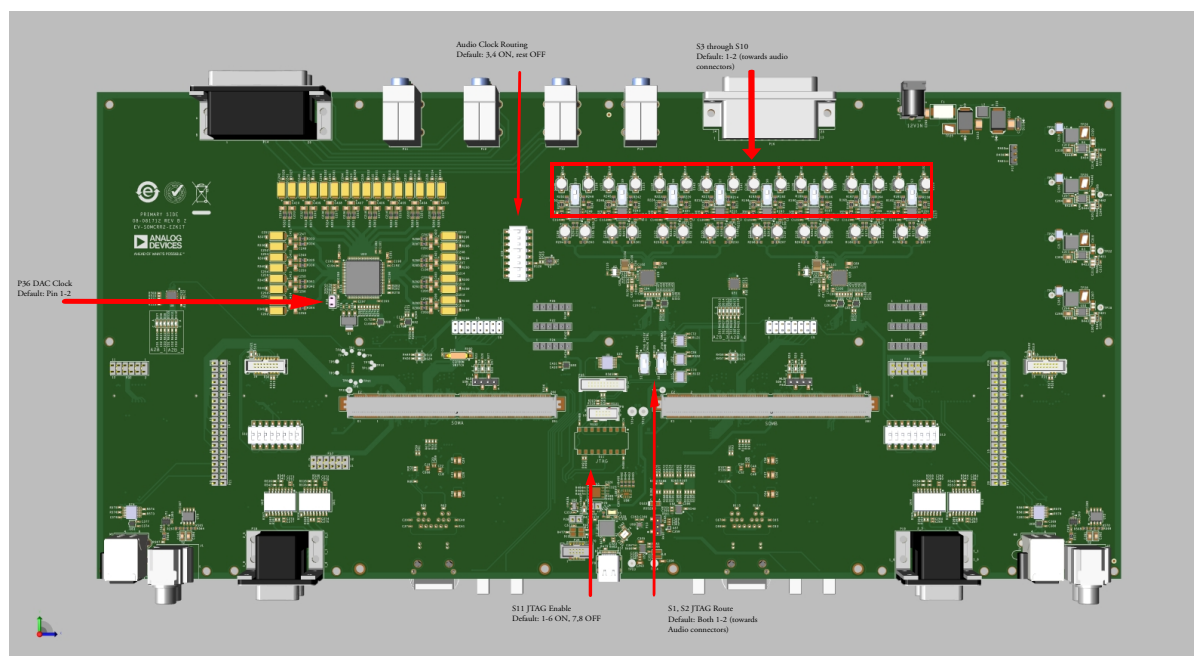


Figure 2-2: Default Hardware Setup

CrossCore Embedded Studio (CCES) Setup

Information on using the CCES tools is available at: <https://analog.com/cces-quickstart>

Debug Agent

The *EV-SOMCRR2-EZKIT* provides a JTAG connection via an onboard Debug Agent. The Debug Agent uses a USB connection to the PC and allows debugging of Analog Devices DSPs without the need of an external ICE.

To use this Debug Agent, all positions on SW1 must be in the ON position. If using an external ICE, such as the ICE-1500, all positions on SW1 must be in the OFF position.

Power-On-Self Test

The Power-On-Self-Test Program (POST) tests all the EZ-KIT carrier board peripherals and validates functionality as well as connectivity to the processor. Once assembled, each EZ-KIT carrier board is fully tested for an extended period of time with POST for all the compatible SoM modules. All EZ-KIT carrier boards are shipped with POST preloaded into flash memory. The POST is executed by resetting the board and connecting the USB To UART to your PC with an open terminal window. The POST also can be used as a reference for a custom software design or hardware troubleshooting.

Note that the source code for the POST program is included in the Board Support Package (BSP) along with the readme file that describes how the board is configured to run POST.

Reference Design Information

A reference design info package is available for download on the Analog Devices Web site. The package provides information on the schematic design, layout, fabrication, and assembly of the board.

The information can be found at:

<http://www.analog.com/EV-SOMCRR2-EZKIT>

Automotive Audio Bus A²B Interface

The Automotive Audio Bus (A²B[®]) provides a multichannel, I²S/TDM link over distances of up to 15 m between nodes. It embeds bidirectional synchronous pulse-code modulation (PCM) data (for example, digital audio), clock, and synchronization signals onto a single differential wire pair. A²B supports a direct point to point connection and allows multiple, daisy-chained nodes at different locations to contribute and/or consume time division multiplexed channel content.

The A²B Interface connects processor evaluation boards, such as the EV-SOMCRR-EZKIT to A²B daughter cards, such as the ADZS-AD2428MINI board. This allows for an expandable and configurable evaluation system for ADI DSPs and A²B technologies.

25LC010AT - 1K SPI Serial EEPROM

The Microchip Technology Inc. 25LC010AT is a 1 Kbit Serial Electrically Erasable Programmable Read-Only Memory (EEPROM). The memory is accessed via a simple Serial Peripheral Interface (SPI) compatible serial bus. The bus signals required are a clock input (SCK) plus separate data in (SI) and data out (SO) lines. Access to the device is controlled through a Chip Select (CS) input.

ADAU1966A - 16 Channel, High Performance, 192kHz, 24-Bit DAC

The ADAU1966A is a high performance, single-chip digital-to-analog converter (DAC) that provides 16 DACs with differential or single-ended output using the patented Analog Devices, Inc., sigma-delta (Σ - Δ) architecture. A SPI/I²C port is included, allowing a micro-controller to adjust volume and many other parameters. The ADAU1966A operates from 2.5 V digital and 3.3 V analog supplies. A linear regulator is included to generate the digital supply voltage from the analog supply voltage.

The ADAU1966A is designed for low EMI. This consideration is apparent in both the system and circuit design architectures. By using the on-board PLL to derive the internal master clock from an external LRCLK, the ADAU1966A can eliminate the need for a separate high frequency master clock and can be used with or without a bit clock. The DACs are designed using the latest Analog Devices continuous time architectures to further minimize EMI.

ADAU1979 - Quad Analog-to-Digital Converter

The ADAU1979 incorporates four high performance, analog-to-digital converters (ADCs) with 4.5 V rms capable ac-coupled inputs. The ADCs use a multibit sigma-delta (Σ - Δ) architecture with continuous time front end for low EMI. An I²C/SPI control port is included that allows a microcontroller to adjust volume and many other parameters. The ADAU1979 uses only a single 3.3 V supply. The device internally generates the required digital DVDD supply. The low power architecture reduces the power consumption. The on-chip PLL can derive the master clock from an external clock input or frame clock (sample rate clock). When fed with the frame clock, it eliminates the need for a separate high frequency master clock in the system.

ADM3056E - Signal and Power Isolated CAN Transceiver

The ADM3056E is a 5.7 kV rms isolated controller area network (CAN) physical layer transceiver. The ADM3056E fully meets the CAN-FD ISO 11898-2: 2016 requirements and is further capable of supporting data rates as high as 12 Mbps.

The device employs Analog Devices, Inc., iCoupler® technology to combine a highly robust 3-channel isolator and a CAN transceiver into a single SOIC, surface-mount package. The ADM3056E provides galvanic isolation between the CAN controller and physical layer bus.

Safety and regulatory approvals (pending) for 5.7 kV rms isolation withstand voltage, 849 VPEAK working insulation voltage, 8 kV surge, and 8.3 mm creepage and clearance, ensure that the ADM3056E meets isolation requirements for high voltage applications.

Low propagation delays through the isolation support longer bus cables. Slope control mode is available for standard CAN at low data rates. Standby mode can minimize power consumption when the bus is idle, or if the node goes offline. Silent mode allows the TXD input to be ignored for listen only functionality.

Dominant timeout functionality protects against bus lock-up in a fault condition, and current limiting and thermal shutdown features protect against output short circuits. The device is fully specified over the -40°C to $+125^{\circ}\text{C}$ industrial temperature range and is available in a 16-lead, increased creepage, wide-body SOIC package.

ADIN1300CCPZ- 10/100/1000 Ethernet Physical Layer

The ADIN1300 is a low power, single port, Gigabit Ethernet transceiver with low latency and power consumption specifications primarily designed for industrial Ethernet applications).

This design integrates an energy efficient Ethernet (EEE) physical layer device (PHY) core with all associated common analog circuitry, input and output clock buffering, management interface and subsystem registers, and MAC interface and control logic to manage the reset and clock control and pin configuration.

The ADIN1300 is available in a 6 mm × 6 mm, 40-lead lead frame chip scale package (LFCSP). The device operates with a minimum of 2 power supplies, 0.9 V and 3.3 V, assuming the use of a 3.3 V MAC interface supply. For maximum flexibility in system level design, a separate VDDIO supply enables the management data input/output (MDIO) and MAC interface supply voltages to be configured independently of the other circuitry on the ADIN1300, allowing operation at 1.8 V, 2.5 V, or 3.3 V. At power-up, the ADIN1300 is held in hardware reset until each of the supplies has crossed its minimum rising threshold value. Brown-out protection is provided by monitoring the supplies to detect if one or more supply drops below a minimum falling threshold (see Table 19 on the datasheet), and holding the device in hardware reset until the power supplies return and satisfy the power-on reset (POR) circuit.

The MII management interface (also referred to as MDIO interface) provides a 2-wire serial interface between a host processor or MAC (also known as management station (STA)) and the ADIN1300, allowing access to control and status information in the PHY core management registers. The interface is compatible with both the IEEE 802.3 Standard Clause 22 and Clause 45 management frame structures.

The ADIN1300 can support cable lengths up to 150 meters at Gigabit speeds and 180 meters when operating at 100 Mbps or 10 Mbps.

IS25LX256 - 256M-bit Serial Octal Flash Memory

The IS25LX256/128 and IS25WX256/128 Serial Flash memory offer a versatile storage solution with high flexibility and performance in a simplified pin count package. ISSI's "Industry Standard Serial Interface" Flash is for systems that require limited space, a low pin count, and low power consumption. The device is compliant with JEDEC Standard xSPI (eXpanded Serial Peripheral Interface).

Nonvolatile and volatile configuration registers enable respective default and temporary settings such as READ operation dummy cycles and wrap modes, memory protection, output buffer impedance, SPI protocol type, and XIP mode.

Memory is organized as uniform 128KB sectors, 4KB and 32KB subsectors, and 256 byte pages. Optional 64KB sectors are also supported.

Direct boot in Octal DDR protocol provides high performance and ease of use, enabling communication between host and device without need to configure extended SPI protocol operations. However, the devices still support both extended SPI and Octal DDR protocols to ensure legacy system support and easy migration path. The extended SPI protocol supports address and data transmission on one or eight data lines, depending on the command.

3 Hardware Reference

This chapter describes the hardware design of the *EV-SOMCRR2-EZKIT* carrier board.

System Architecture

The board's configuration is shown in the *Block Diagram* figure.

EV-SOMCRR2-EZKIT Overview

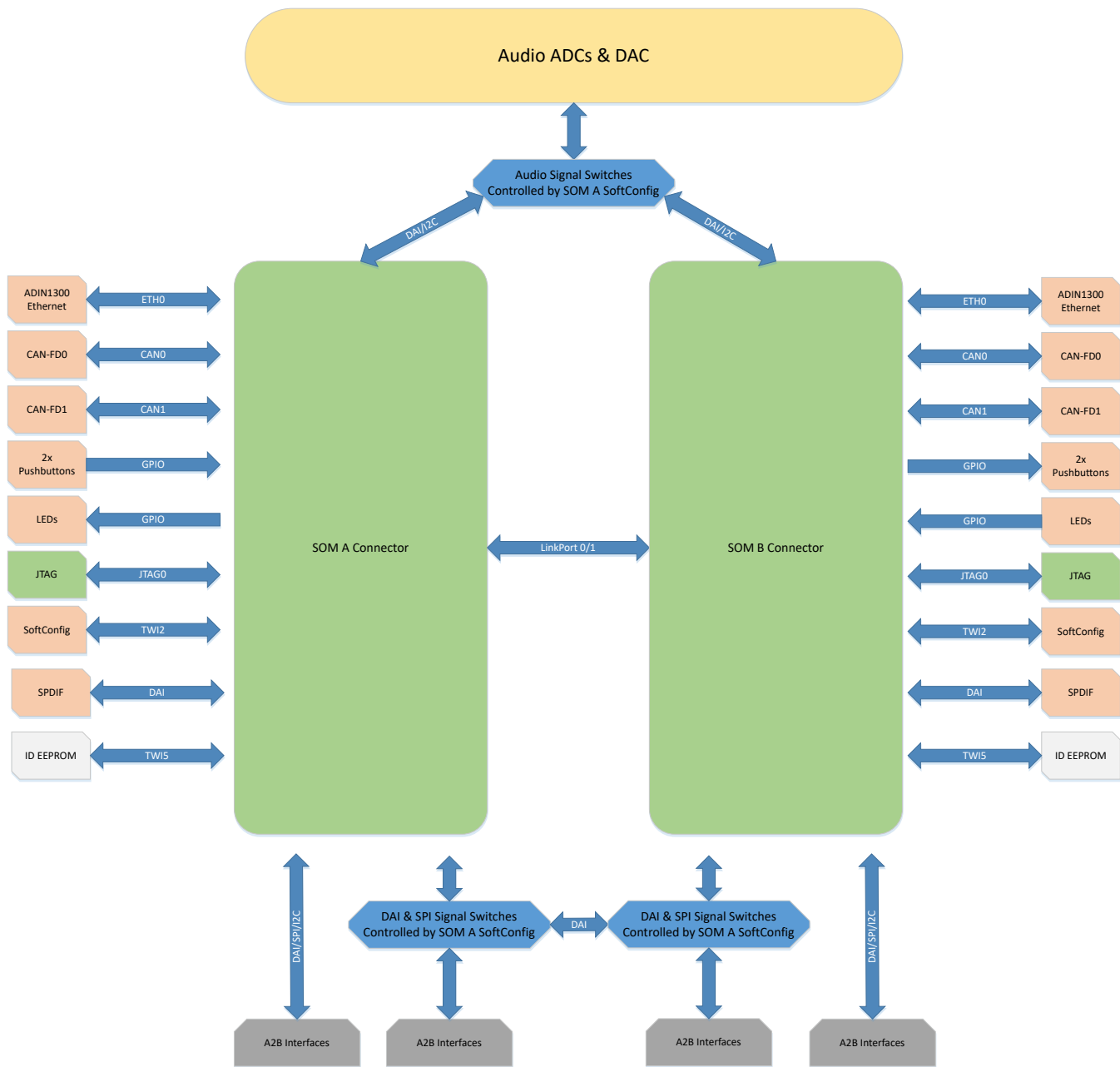


Figure 3-1: Block Diagram

This Carrier board is designed to demonstrate the connected System on Module processor's capabilities. The peripherals help evaluate the processor's features with audio DAC and ADCs, S/PDIF, 10/100/1000 ethernet, CAN, and A²B expansion.

User I/O to the processor is provided in the form of two pushbuttons and three LEDs.

The software-controlled switches (SoftConfig) facilitate the switch multi-functionality by disconnecting the pushbuttons from their associated processor pins and reusing the pins elsewhere on the board.

Software-Controlled Switches (SoftConfig)

On the board, most of the traditional mechanical switches and jumpers have been replaced by I²C software-controlled switches. The remaining mechanical switches are provided for the boot mode and pushbuttons. Reference any `SoftConfig*.c` file found in the installation directory for an example of how to set up the SoftConfig feature of the board through software. The SoftConfig section of this manual serves as a reference to any user that intends to modify an existing software example. If software provided by ADI is used, there should be little need to reference this section.

NOTE: Care should be taken when changing SoftConfig settings not to create a conflict with interfaces. This is especially true when connecting extender cards.

Overview of SoftConfig

In order to further clarify the use of electronic single FET switches and multi-channel bus switches, an example of each is illustrated and compared to a traditional mechanical switching solution. This is a generic example that uses similar FET and bus switch components that are on the board.

After this generic discussion, there is a detailed explanation of the SoftConfig interface specific to the *EV-SOMCRR2-EZKIT* carrier board.

The *Example of Individual FET Switches* figure shows two individual FET switches (Pericom PI3A125CEX) with reference designators UA and UB. Net names `ENABLE_A` and `ENABLE_B` control UA and UB. The default FET switch enable settings in this example are controlled by resistors RA and RB, which pull the enable pin 1 of UA and UB to ground (low), respectively. In a real example, these enable signals are controlled by the Microchip I/O expander. The default pull-down resistors connects the signals `EXAMPLE_SIGNAL_A` and `EXAMPLE_SIGNAL_B` and also connects signals `EXAMPLE_SIGNAL_C` and `EXAMPLE_SIGNAL_D`. To disconnect `EXAMPLE_SIGNAL_A` from `EXAMPLE_SIGNAL_B`, the Microchip I/O expander is used to change `ENABLE_A` to a logic 1 through software that interfaces with the Microchip I/O expander. The same procedure for `ENABLE_B` disconnects `EXAMPLE_SIGNAL_C` from `EXAMPLE_SIGNAL_D`.

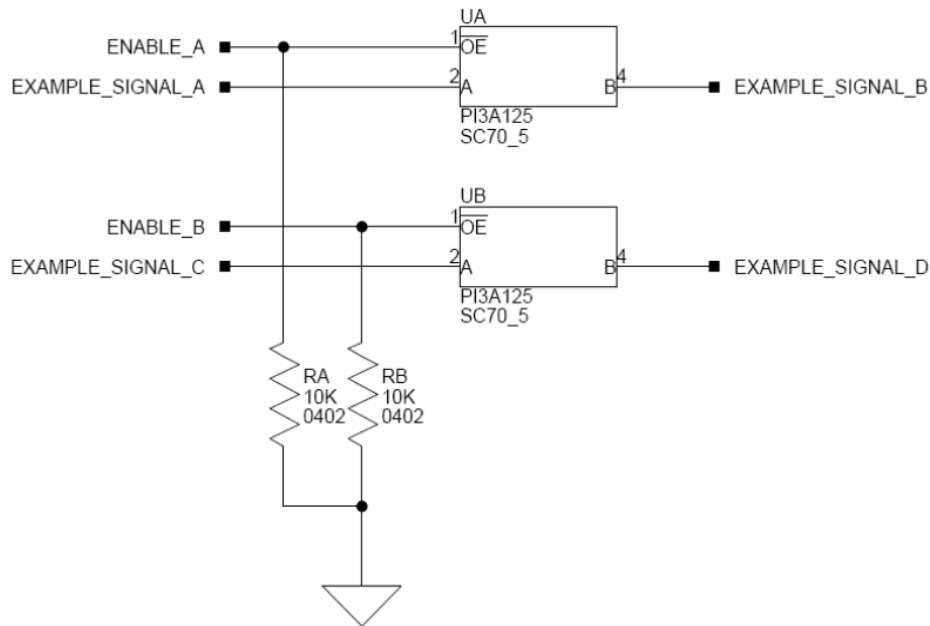


Figure 3-2: Example of Individual FET Switches

The following figure shows the equivalent circuit to the *Example of Individual FET Switches* figure but utilizes mechanical switches that are in the same package. Notice the default is shown by black boxes located closer to the **ON** label of the switches. In order to disconnect these switches, physically move the switch to the OFF position.

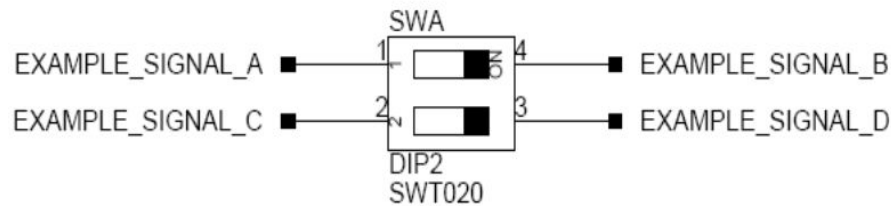


Figure 3-3: Example of a Mechanical Switch (Equivalent to Example of Individual FET Switches Figure)

The *Example of Bus Switch* figure shows a bus switch example, reference designator UC (Pericom PI3LVD512ZHE), selecting between lettered functionality and numbered functionality. The signals on the left side are multiplexed signals with naming convention letter_number. The right side of the circuit shows the signals separated into letter and number, with the number on the lower group (0B1) and the letter on the upper group (0B2). The default setting is controlled by the signal CONTROL_LETTER_NUMBER which is pulled low. This selects the number signals on the right to be connected to the multiplexed signals on the left by default. In this example, the Microchip IO expander is not shown but controls the signal CONTROL_LETTER_NUMBER and allows the user to change the selection through software.

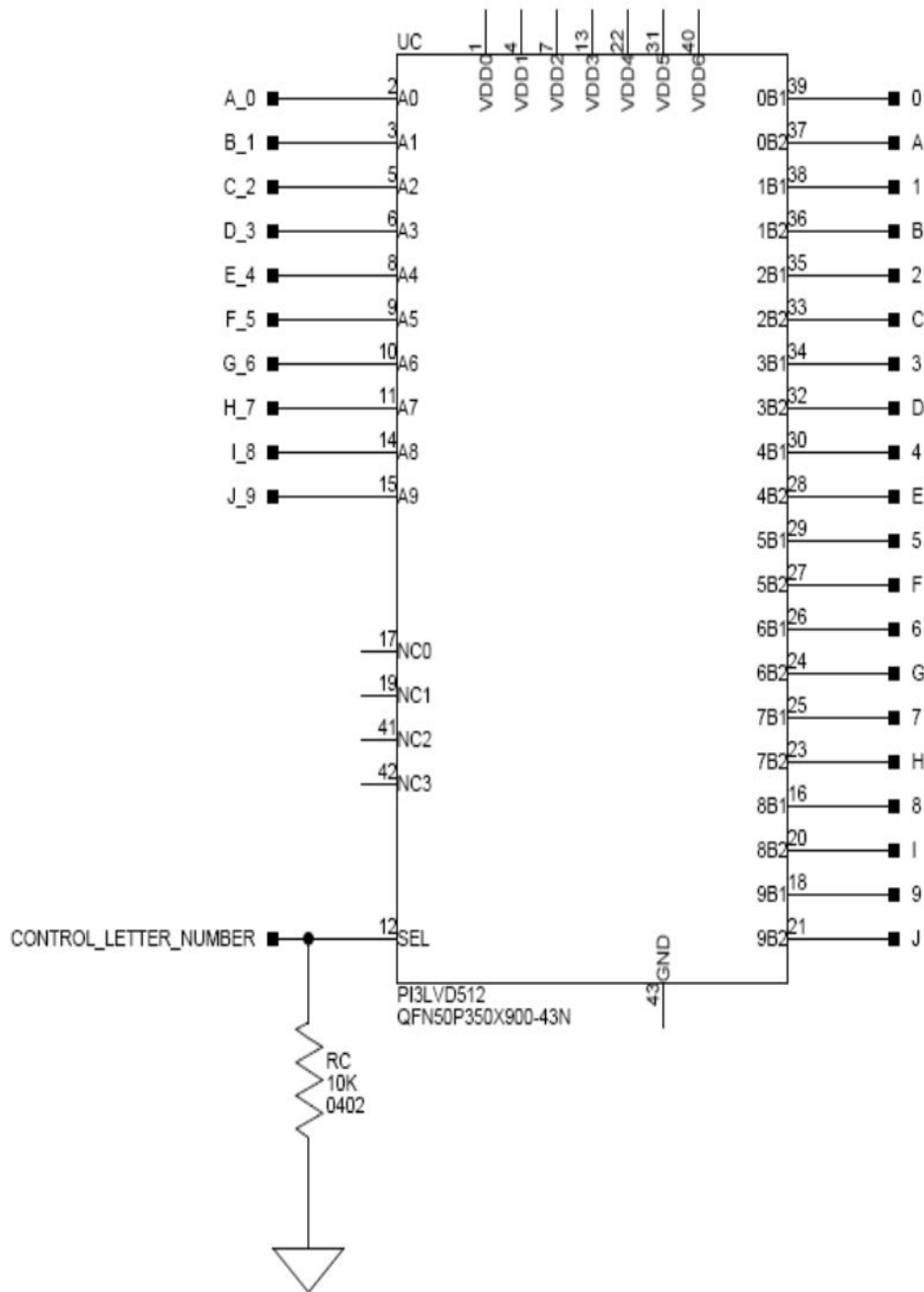


Figure 3-4: Example of a Bus Switch

The following figure shows the equivalent circuit to the *Example of Bus Switch* figure but utilizes mechanical switches. Notice the default for reference designators SWC and SWD is illustrated by black boxes located closer to the *ON* label of the switches to enable the number signals by default. Also notice the default setting for reference designators SWE and SWF is OFF. In order to connect the letters instead of the numbers, the user physically changes all switches on SWC and SWD to the OFF position and all switches on SWE and SEF to the ON position.

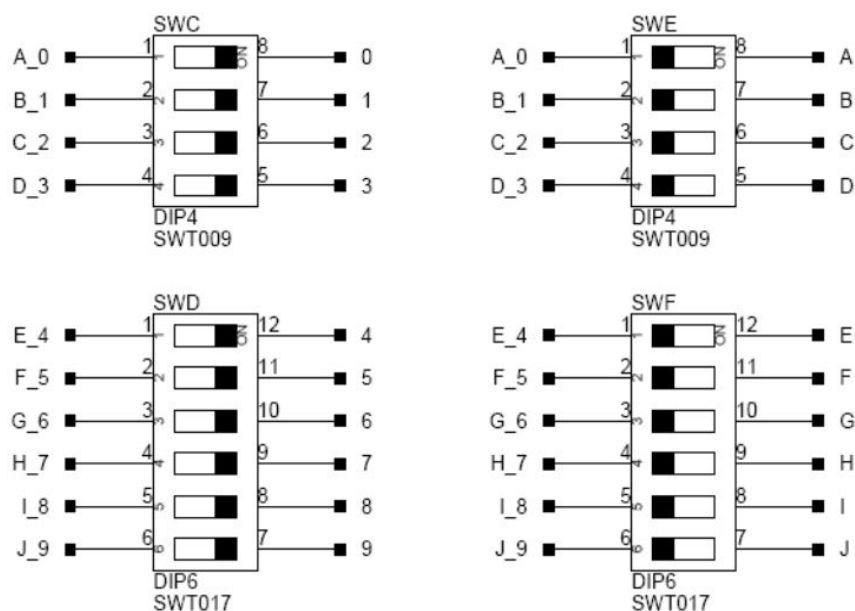


Figure 3-5: Example of a Mechanical Switch (Equivalent to Example of Bus Switch)

SoftConfig on the Board

Two Microchip ADP5587 GPIO expanders provide control for individual electronic switches. The TWI interface of the processor communicates with the Microchip devices. There are individual switches with default settings that enable basic board functionality.

The *Default Processor Interface Availability* table lists the processor and board interfaces that are available by default. Note that only interfaces affected by software switches are listed in the table.

Table 3-1: Default Processor Interface Availability

Interface	Availability by Default
SPDIF Analog	Disabled
SPDIF Digital	Disabled
ADAU1966 Reset	Enabled
ADAU19179_A Reset	Enabled
ADAU19179_B Reset	Enabled
ADC1 Route	Connected to SOM A
ADC2 Route	Connected to SOM A
Push Buttons Enabled	Enabled

Programming SoftConfig Switches

On the board, an ADI ADP5587-1 devices exist. The ADP5587 can be configured as a GPIO extender or a keypad interface. It is used as a GPIO Extended on the System on Module evaluation board.

Refer to the ADP5587-1 datasheet for programming information. <https://www.analog.com/media/en/technical-documentation/data-sheets/adp5587.pdf>

Each example in the Board Support Software (BSP) includes source files that program the soft switches, even if the default settings are being used. The README for each example identifies only the signals that are being changed from their default values. The code that programs the soft switches is located in the `SoftConfig_XXX.c` file in each example where XXX is the name of the board.

The part number of the ADP5587-1 determines the address of the IC. The ADP5587ACPZ has *I²C Hardware Address 0x68* and the ADP5587ACPZ-1 has *I²C Hardware Address 0x60*.

Table below *Output Signals of ADP5587-1 GPIO Expander (U8)* show the output signals of the ADI GPIO extender (U8), with a TWI address of 0110 100X, where X represents the read or write bit. The signals that control an individual FET have an entry in the *FET* column. The *Component Connected* column shows the board IC that is connected if the FET is enabled. The (U8) is controlling the enable signal of a FET switch. Also note that if a particular functionality of the processor signal is being used, it is in **bold** font in the *Processor Signal* column.

Table 3-2: Output Signals of ADP5587-1 GPIO Extender (U8) for SOM A

Con- nec- tion	Signal Name	Description	FET	Processor Signal (if applicable)	Connected	Default
R0	ETH0_RESET*	ADIN1300 Reset		None	U1	High
R1	SPDIF1_EN	SPDIF1 Enable	U67	None	M1	High
R2	ADAU1966A_RESET_SOM_A	ADAU1966A DAC Reset		None	U33	High
R3	ADAU1979_A_RESET_SOM_A	ADAU1979 A Reset		None	U18	High
R4	ADAU19179_B_RESET_SOM_A	ADAU1979 B Reset		None	U19	High
R5	PUSHBUTTON_A_EN	Enable Pushbuttons on SOM A	U7			High
R6	SPDIF1_OPT_EN	Enables SPDIF Optical on SOM A	U74		M1	High
R0	SPDIF1_COAX_EN	Enables SPDIF COAX on SOM A	U74		U70	High
C0	ADC1_ROUTE	Sets which SOM ADC1 is routed	U34, U35		U18	High
C1	ADC2_ROUTE	Sets which SOM ADC2 is routed	U36, U37		U19	High
C2	DAC Route	Sets which SOM DAC is routed	U38, U39, U40		U33	High

Table 3-2: Output Signals of ADP5587-1 GPIO Extender (U8) for SOM A (Continued)

Con- nec- tion	Signal Name	Description	FET	Processor Signal (if applicable)	Connected	Default
C3	DAI1_ROUTE	Route DAI1 signals between A2B connectors or between SOM A and B modules.	U45, U47	DAI1_PIN17, DAI1_PIN18, DAI1_PIN19, DAI1_PIN20	SOM A2B Connector s or SOM A to SOM B	High
C4	QSPI_ROUTE	Route SQPI signals between A2B connectors or between SOM A and B modules.	U46, U48	QSPI_CLK, QSPI_CITO, QSPI_COTI, QSPI_SEL1	SOM A2B Connector s or SOM A to SOM B	High
C5	A2B1_IO1	A2B1 IO1 Signal.				High
C6	A2B1_IO1	A2B1 IO2 Signal.				High
C7	A2B1_IO7	A2B1 IO7 Signal.				High
C8	A2B2_IO1	A2B2 IO1 Signal.				High
C9	A2B2_IO2	A2B2 IO2 Signal.				High

Table 3-3: Output Signals of ADP5587-1 GPIO Extender (U51) for SOM B

Con- nec- tion	Signal Name	Description	FET	Processor Signal (if applicable)	Connected	Default
R0	ETH0_RESET*	ADIN1300 Reset		None	U2	High
R1	SPDIF2_EN	SPDIF2 Enable	U69	None	M2	High
R2	ADAU1966A_RESET_SOM_B	ADAU1966A DAC Reset		None	U33	High
R3	ADAU1979_A_RESET_SOM_B	ADAU1979 B Reset		None	U18	High
R4	ADAU19179_B_RESET_SOM_B	ADAU1979 B Reset		None	U19	High
R5	PUSHBUTTON_B_EN	Enable Pushbuttons on SOM B	U7			High
R6	SPDIF2_OPT_EN	Enables SPDIF Optical on SOM B	U75	DAI0_PIN19, DAI0_PIN20	M2	High
R0	SPDIF2_COAX_EN	Enables SPDIF COAX on SOM B	U75	DAI0_PIN19, DAI0_PIN20	U72	High
C0						

Table 3-3: Output Signals of ADP5587-1 GPIO Extender (U51) for SOM B (Continued)

Con- nec- tion	Signal Name	Description	FET	Processor Signal (if applicable)	Connected	Default
C1						
C2						
C3						
C4						
C5	A2B1_IO1	A2B1 IO1 Signal.				High
C6	A2B1_IO1	A2B1 IO2 Signal.				High
C7	A2B1_IO7	A2B1 IO7 Signal.				High
C8	A2B2_IO1	A2B2 IO1 Signal.				High
C9	A2B2_IO2	A2B2 IO2 Signal.				High

Switches

This section describes operation of the switches. The switch locations are shown in the *Switch/Jumper Locations* figure.

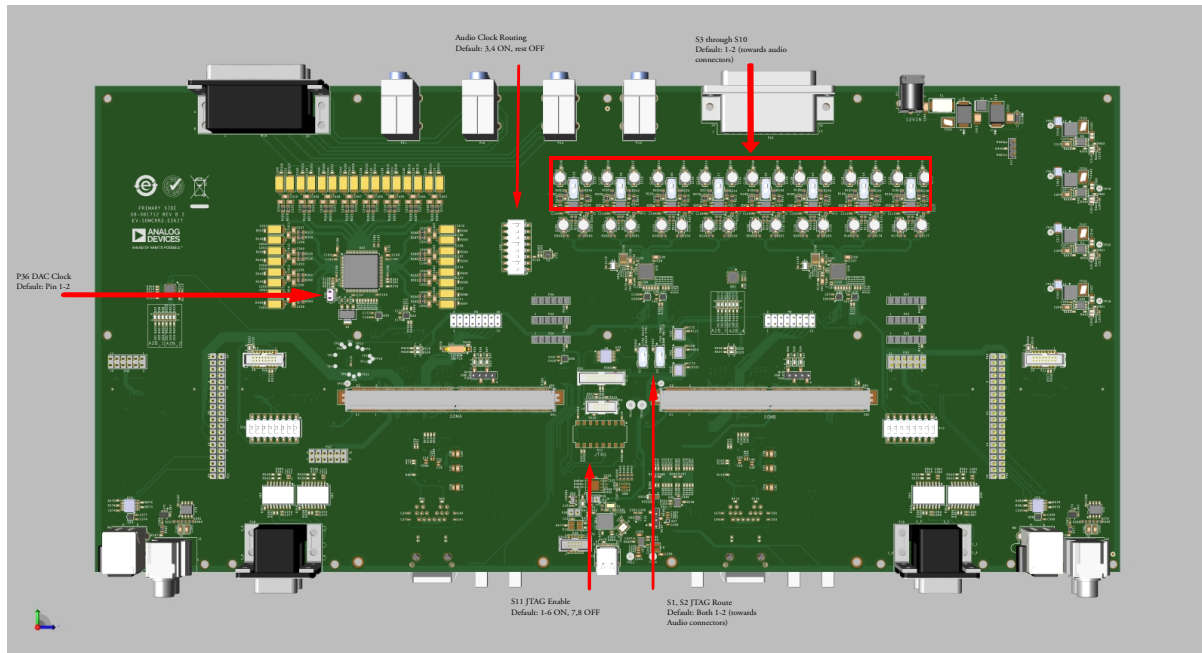


Figure 3-6: Switch/Jumper Locations

Reset Pushbutton (RESET)

The reset pushbutton resets the ADI processor. The reset signal also is connected to the SoM interface connectors via the SYS_HWRST signal. [Reset \(DS23\)](#) is used to indicate when the board is in reset.

GPIO Pushbuttons (PB1 , PB2 , PB3 , PB4)

The GPIO pushbuttons are connected to the processor's signals GPIO1 and GPIO2, respectively.

The GPIO pushbuttons can be disconnected from the processor by setting SoftConfig. See [Software-Controlled Switches \(SoftConfig\)](#) for more information.

JTAG Interface (s11)

The JTAG Interface switch enables/disables the on-board debug agent. When in the disabled configuration, an ICE can be attached to the JTAG header on the SoM module to provide on-chip debug capabilities.

Table 3-4: Debug Agent Enable

Location	Position
SW11.1	ON
SW11.2	ON
SW11.3	ON
SW11.4	ON
SW11.5	ON
SW11.6	ON
SW11.7	OFF
SW11.8	OFF

Table 3-5: Debug Agent Disable

Location	Position
SW11.1	OFF
SW11.2	OFF
SW11.3	OFF
SW11.4	OFF
SW11.5	OFF
SW11.6	OFF
SW11.7	OFF
SW11.8	OFF

The EV-SOMCRR2-EZKIT has a JTAG routing circuit that can routing the Debug Agent (or emulator) to SOM A or SOM B, or Daisy Chain them both into the same route.

Table 3-6: JTAG Routing Direct to SOM A

Location	Position
S1	1-2
S2	1-2

Table 3-7: JTAG Routing Direct to SOM B

Location	Position
S1	1-2
S2	2-3

Table 3-8: JTAG Routing Daisy Chain

Location	Position
S1	2-3
S2	1-2

Jumpers

This section describes the functionality of the configuration jumpers. The *Switch/Jumper Locations* figure shows the jumper locations.

DAC Clock(P36)

The DAC Clock jumper connects 24.576 MHz to the MCLKI of the ADAU1966A DAC. This also connects to the DAC_AUDIO_CLK signal.

HADC (P4 and P5)

The HADC jumper is used to connect the HADC of the processor to various voltages using jumper wires.

P4 Jumper	Voltage
1 and 2	GND
3 and 4	GND
5 and 6	GND
7 and 8	GND
9 and 10	GND

P4 Jumper	Voltage
11 and 12	GND
13 and 14	GND
15 and 16	GND

LEDs

This section describes the on-board LEDs. The *LED Locations* figure shows the LED locations.

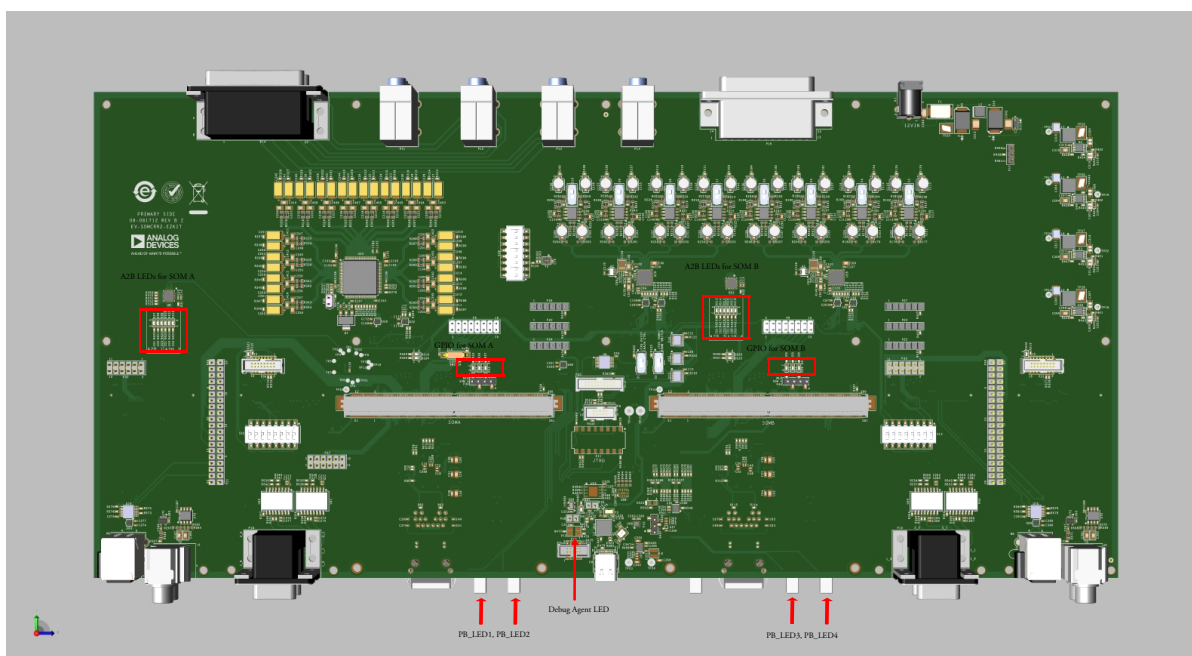


Figure 3-7: LED Locations

A²B Interface LEDs (DS7, DS8, DS9, DS10, DS11, DS12)

The A²B Interface LEDs are driven by the connected A2B daughter card on the A2B Interface Connectors. These are connected to A2B IRQ and GPIO signals. Refere to the schematics of the connected A2B or related daughter card for more information.

GPIO (DS1, DS2, DS3, DS4, DS5, DS6, PB1_LED, PB2_LED, PB3_LED, PB4_LED)

5 LEDs are connected to the general-purpose I/O pins of the processor in each of the SOM connectors.(see the *GPIO LEDs* table). The LEDs are active high and are turned ON (amber) by writing a 1 to the correct processor signal.

Table 3-9: GPIO LEDs

<i>Reference Designator</i>	<i>Programmable Flag Pin</i>
<i>DS1</i>	MLB_CLK_SOM_A
<i>DS2</i>	MLB_SIG_SOM_A
<i>DS3</i>	MLB_DAT_SOM_A
<i>PB1_LED</i>	PB1_LED
<i>PB2_LED</i>	PB2_LED
<i>DS4</i>	MLB_CLK_SOM_B
<i>DS5</i>	MLB_SIG_SOM_B
<i>DS6</i>	MLB_DAT_SOM_B
<i>PB3_LED</i>	PB3_LED
<i>PB4_LED</i>	PB4_LED

Reset (DS23)

When ON (red), it indicates that the board is in reset. A master reset is asserted by pressing RESET, which activates the LED. For more information, see [Reset Pushbutton \(RESET\)](#).

Connectors

This section describes connector functionality and provides information about mating connectors. The connector locations are shown in the *Connector Top* and *Connector Bottom* figures.

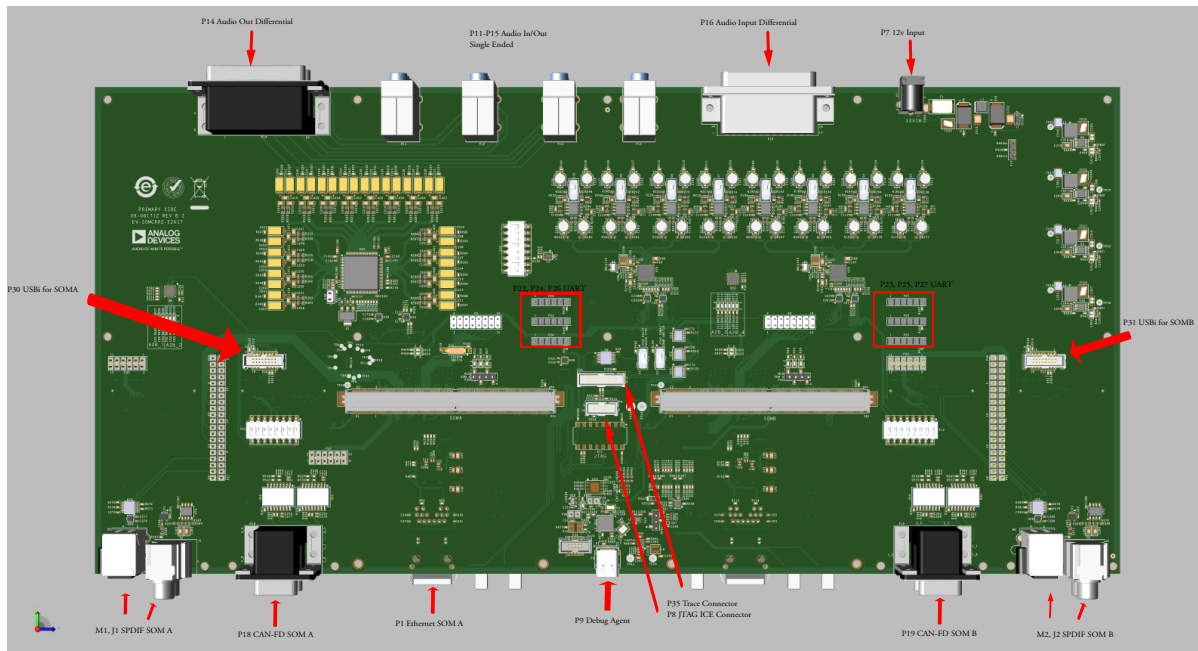


Figure 3-8: Connector Top

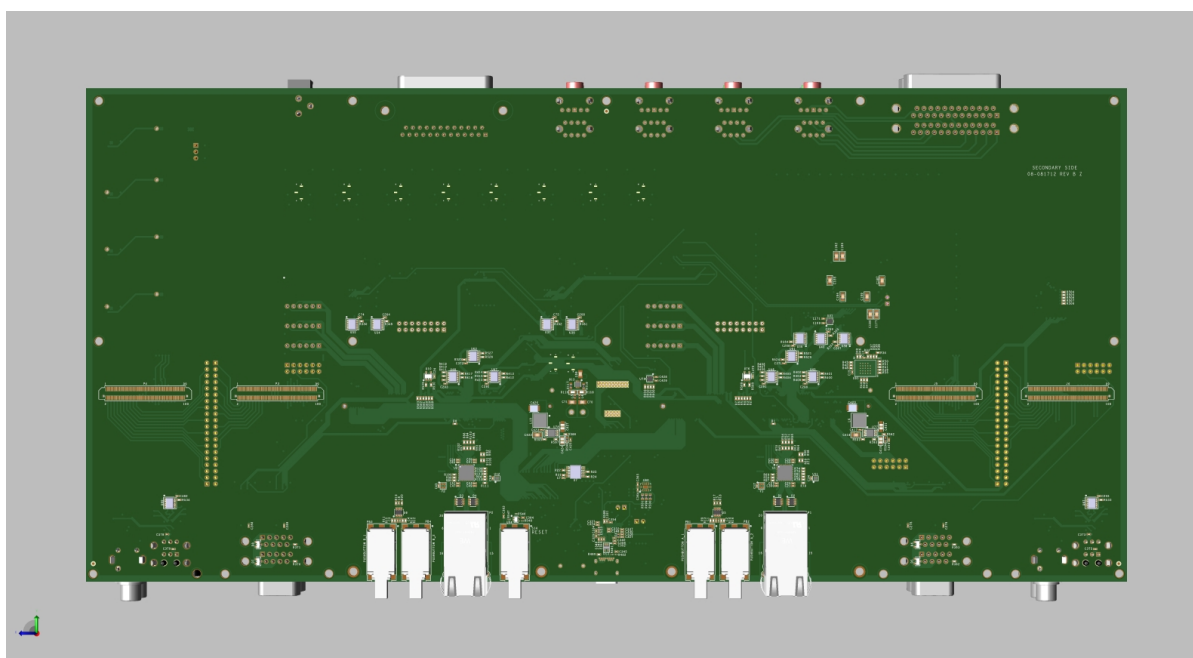


Figure 3-9: Connector Bottom

SoM 2.0 Interface Connection (SOMA , SOMB)

The SoM 2.0 Interface Connector is a PCB Finger Edge connector designs to connect to the Amphenol ICC 10151114-001TLF. This interface

Table 3-10: SoM 2.0 Interface (Finger Edge)

Pin	Signal	Pin	Signal	Pin	Signal	Pin	Signal	Pin	Signal
E1	VDD_SOM +5V	57	DAI1_PIN04	117	PC_07	177		237	PG_14
E2	VDD_SOM +5V	58	DAI1_PIN14	118	PC_12	178	PD_06	238	GND
E3	GND	59	DAI1_PIN05	119	PB_09	179		239	PG_15
E4	GND	60	DAI1_PIN15	120	PC_14	180	GND	240	
1	TRACE0_CLK	61	DAI1_PIN06	121	GND	181	GND	241	PH_00
2	XSPI1_DQS_RW DS*	62	DAI1_PIN16	122	PC_13	182	PD_09	242	
3	TRACE0_D00	63	DAI1_PIN07	123	PG_01	183		243	BMODE0
4	XSPI1_COTI_D0	64	DAI1_PIN17	124	GND	184	PD_08	244	
5	TRACE0_D01	65	DAI1_PIN08	125	PG_00	185		245	BMODE1
6	XSPI1_CITO_D1	66	DAI1_PIN18	126	N/A	186	GND	246	
7	TRACE0_D02	67	DAI1_PIN09	127	N/A	187		247	BMODE2
8	XSPI1_D2	68	DAI1_PIN19	128	N/A	188	PA_00	248	

Table 3-10: SoM 2.0 Interface (Finger Edge) (Continued)

Pin	Signal	Pin	Signal	Pin	Signal	Pin	Signal	Pin	Signal
9	TRACE0_D03	69	DAI1_PIN10	129	N/A	189		249	BMODE3
10	XSPI1_D3	70	DAI1_PIN20	130	N/A	190	PA_01	250	
11	TRACE0_D04	71	GND	131	N/A	191	GND	251	GND
12	XSPI1_D4	72	GND	132	N/A	192	PA_02	252	
13	TRACE0_D05	73	GND	133	GND	193	GND	253	PF_04
14	XSPI1_D5	74	HADC_VIN0	134	GND	194	PA_03	254	
15	TRACE0_D06	75	PH_01	135		195		255	PF_05
16	XSPI1_D6	76	HADC_VIN1	136	JTG_TMS	196	GND	256	
17	TRACE0_D07	77	PG_02	137		197		257	PF_06
18	XSPI1_D7	78	HADC_VIN2	138	JTG_TCK	198	PA_05	258	
19		79	PG_03	139		199		259	PF_07
20	XSPI1_SEL1*	80	HADC_VIN3	140	JTG_TDO	200	PA_04	260	
21	PD_04	81	PG_08	141		201		261	PF_08
22	XSPI1_SEL2*	82	HADC_VIN4	142	JTG_TDI	202	PA_06	262	CARRIER_DE-TECT*
23	PB_07	83	PG_09	143		203	GND	263	PF_09
24	XSPI1_CLK*	84	HADC_VIN5	144	JTG_TRST*	204	PA_07	264	EEPROM_ID0
25	PB_08	85	GND	145	GND	205		265	GND
26	XSPI1_CLK	86	HADC_VIN6	146	TARGET_RE-SET*	206	GND	266	EEPROM_ID1
27	GND	87	PG_04	147		207		267	PF_10
28	GND	88	HADC_VIN7	148	GND	208	PH_07	268	GND
29	DAI0_PIN01	89	PG_06	149		209		269	PF_11
30	DAI0_PIN11	90	GND	150	PA_09	210	PH_06	270	
31	DAI0_PIN02	91	PG_07	151		211		271	PF_12
32	DAI0_OIN12	92	PC_04	152	PA_08	212	PH_08	272	GND
33	DAI0_PIN03	93	PG_12	153		213	GND	273	PF_13
34	DAI0_PIN13	94	PC_00	154	GND	214	PH_09	274	TARGET_RE-SET*
35	DAI0_PIN04	95	PG_13	155		215		275	PF_14
36	DAI0_PIN14	96	PC_01	156	PA_11	216	GND	276	SYS_FAULT*
37	DAI0_PIN05	97	GND	157	GND	217		277	PF_15

Table 3-10: SoM 2.0 Interface (Finger Edge) (Continued)

Pin	Signal	Pin	Signal	Pin	Signal	Pin	Signal	Pin	Signal
38	DAI0_PIN15	98	PC_02	158	PA_10	218		278	GND
39	DAI0_PIN06	99	PG_05	159		219		279	GND
40	DAI0_PIN16	100	PC_03	160	GND	220		280	GND
41	DAI0_PIN07	101	PG_11	161		221		281	GND
42	DAI0_PIN17	102	PC_05	162	PA_13	222			
43	DAI0_PIN08	103	PG_10	163		223	GND		
44	DAI0_PIN18	104	PC_06	164	PA_12	224			
45	DAI0_PIN09	105	PH_02	165		225	PA_15		
46	DAI0_PIN19	106	PC_07	166	GND	226			
47	DAI0_PIN10	107	PH_03	167		227	PA_14		
48	DAI0_PIN20	108	PC_08	168	PB_06	228			
49	GND	109	GND	169	GND	229	GND		
50	GND	110	GND	170	PB_05	230			
51	DAI1_PIN01	111	PH_05	171		231	PB_01		
52	DAI1_PIN11	112	PC_09	172	PB_04	232			
53	DAI1_PIN02	113	PH_04	173		233	PB_00		
54	DAI1_PIN12	114	PC_10	174	GND	234			
55	DAI1_PIN03	115	PC_06	175		235	GND		
56	DAI1_PIN13	116	PC_11	176	PD_07	236			

Table 3-11: Mating Connector

<i>Part Description</i>	<i>Manufacturer</i>	<i>Part Number</i>
314 Pin MXM 3.0		PCB Edge
<i>Mating Connector</i>		
314 Pin PCI Express	Amphenol	10151114-001TLF

Audio Input/Output (P13 , P15 , P16)

<i>Part Description</i>	<i>Manufacturer</i>	<i>Part Number</i>
3.5mm Stereo female	Kycon, Inc.	STX-4335-5BGP-S1
DB25 connector	NorComp, Inc.	178-025-513R571
<i>Mating Cable</i>		

<i>Part Description</i>	<i>Manufacturer</i>	<i>Part Number</i>
Standard 3.5mm stereo cable		

Audio Output (P11 , P12 , P13 , P14)

<i>Part Description</i>	<i>Manufacturer</i>	<i>Part Number</i>
3.5mm Stereo female	Kycon, Inc.	STX-4335-5BGP-S1
<i>Mating Cable</i>		
Standard 3.5mm stereo cable		

S/PDIF Digital (J1 , J2)

<i>Part Description</i>	<i>Manufacturer</i>	<i>Part Number</i>
RCA 1x2 female	Switchcraft	PJRAS1X2S02X
<i>Mating Cable</i>		
Standard S/PDIF cable with RCA connectors		

S/PDIF Optical Tx/RX (M1 , M2)

<i>Part Description</i>	<i>Manufacturer</i>	<i>Part Number</i>
Fiber optic transmitter	CLIFF Electronics	FC6842135TR
<i>Mating Cable</i>		
Standard TOSLINK optical digital cable		

MLB (P38 , P42)

<i>Part Description</i>	<i>Manufacturer</i>	<i>Part Number</i>
4 Pin	Samtec	TSM-104-01-T-SV

Sigma Studio (P30 , P31)

This connector interfaces with SigmaStudio[®] through the EVAL-ADUSB2EBZ board. The connector is a 0.1" header. The pinout can be found in the schematic.

A²B (J4 , J5 , P3 , P4)

<i>Part Description</i>	<i>Manufacturer</i>	<i>Part Number</i>
100-pin, 0.64mm	SAMTEC	LSS-150-01-L-DV-A-K
<i>Mating Connector</i>		
100-pin, 0.64mm	SAMTEC	LSS-150-01-L-DV-A-K

Ethernet 10/100/1000 (P1 , P2)

<i>Part Description</i>	<i>Manufacturer</i>	<i>Part Number</i>
RJ45	WURTH	7499511440
<i>Mating Cable</i>		
Standard CAT5e Ethernet cable		

Power Plug (P7)

<i>Part Description</i>	<i>Manufacturer</i>	<i>Part Number</i>
2.1 mm power jack	CUI	PJ-102AH
<i>Mating Cable</i>		
12.0VDC@1.5A power supply	CUI	EMSA120150-P5RP-SZ

